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NPN/45V/200MA

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Test Standards:

- Moisture Sensitivity: NA
- Physical Dimensions: TO-92

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| Attribute | Value |
|-------------------------------------------|-----------------------------------------------------------------------|
| General Information | |
| Device Marking(TOP MARK) | KS 3302 -&3 |
| Family Code | 0S2 |
| Package Type | TO-92 |
| Package Description | 3 LD PLASTIC PKG (APK=AM) |
| Pin Count | 3 |
| FIT | 9.2 |
| Maximum Reflow Temperature | NA (thru hole) |
| MSL Rating | NA (thru hole) |
| Restriction of Hazardous Substance | |
| Standard Plating Finish | Matte Sn |
| Base Metal/Leadframe Material | Copper,Iron,Phosphorus,Silver |

| | |
|--------------------------------|--------------|
| Lead Pitch | 1270 |
| Minimum Lead Spacing | 810 |
| Die Fabrication | |
| Fabrication Process Identifier | DB0815A |
| Package Assembly* | |
| Plating Finish Layer Thickness | 8.0um - 18um |
| Moisture Sensitivity | NA |

*If an attribute is listed twice, either can be used on the part.

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